Cascade

|Z| Probe Power

High-Power, High Performance Wafer Probe

Overview

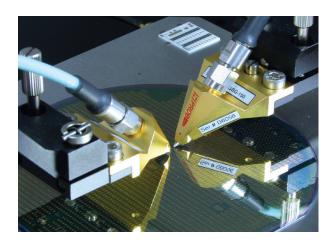
The demand for access to rich content anywhere in the world is driving the growth of wireless transmission of information. This increases the need for RF power devices in wireless systems and new technologies such as GaN and SiC. This in turn necessitates the characterization of these new technologies at wafer-level, which significantly reduces the time needed to develop new models. These models are used in new device designs, which are then further implemented in wireless transmission systems (base stations, satellites, etc.) to meet the demands of the content-hungry consumer.

To provide highly accurate characterization of RF power devices at wafer level, FormFactor has developed Cascade |Z| Probe Power, based off proven |Z| Probe technology, which can handle up to 66 W at 2.4 GHz and 43 W at 5 GHz. The |Z| Probe Power provides excellent contact repeatability and extremely low contact resistance to deliver the most accurate results up to 40 GHz in load-pull measurement setups, which are typical for characterizing RF power devices.

The |Z| Probe Power is optimized even further for load-pull and noise-parameter measurements. Insertion loss, a critical value in these measurements, must be kept low in order to

keep the reflection coefficient (Γ) high. The |Z| Probe Power has a typical insertion loss of 0.4 dB up to 40 GHz – a more than 70% improvement over standard |Z| Probe. This means you get more accurate measurements especially at non-50 Ω impedances.

Thanks to the proven |Z| Probe technology, the probe also has an extremely long lifetime. FormFactor guarantees that the probe has a useful life of at least 1,000,000 contact cycles under standard use and overtravel. No other RF probe provides such outstanding electrical performance and long lifetime, both characteristics that are a result of FormFactor's pioneering work in developing nickel contact tips. As a result, the |Z| Probe Power is perfect for probing on aluminum and gold pads, and the ideal choice for your on-wafer RF power device characterization needs.



> Features and Benefits

High-power RF measurement	 Lowest DC resistance enables high power throughput
	 Lowest insertion loss and highest possible return loss
	 Unparalleled repeatable and reliable contact quality
Pulsed signal measurement	 More than twice the specified power rating (depending on pulse characteristics)
Small pads, structures and uneven surfaces	•40 μm x 40 μm pads can be tested
	•Pad height differences of up to 50 μm can easily be handled
Accurate load-pull measurements	 Very-low insertion loss makes the probes ideal for on-wafer load-pull measurements
	 Nickel spring contacts enable safe and stable contact even on aluminum pads and under small vibrations

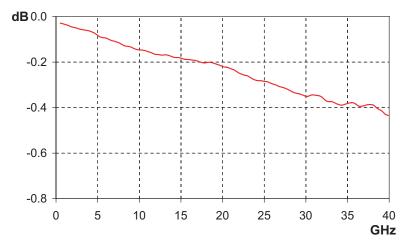
> Mechanical Specifications

Electrical Characteristics

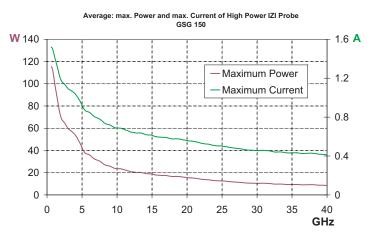
Characteristic impedance	50 Ω
Frequency range	DC to 40 GHz
Insertion loss	< 0.5 dB DC to 40 GHz (0.4 dB typical)
Average maximum RF power DC current	9 W (40 GHz), 25 W (10 GHz), 60 W (2 GHz) (CW**)
• DC current	Maximum 2 A
Contact resistance on Au	< 0.04 Ω
Mechanical characteristics	
Contact springs	Nickel
• Insulator	RF dielectric
Lifetime	> 1,000,000 contact cycles
Maximum contact pressure	6 N/mm
Available pitches (m)	100, 125, 150, 200, 250, 300, 350, 400, 450, 500 μm
Connector	
• Туре	PC 2.92 mm, female
Coupling torque	0.8 to 1.1 Nm (recommended)
Outer contact	Stainless steel
Center contact	CuBe with Au plating
• Insulator	PEEK
Environmental Data	
Temperature range	- 100° C to 200° C

^{*} Data, design and specification depend on individual process conditions and can vary according to equipment configurations. Not all specifications may be valid simultaneously.

^{**} Continuous Wave - An electromagnetic wave generated as an unbroken train of constant frequency and amplitude, rather than in pulses.



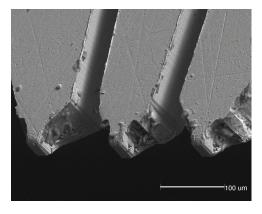


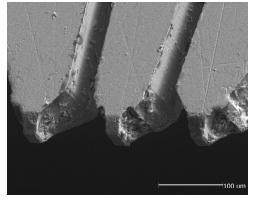


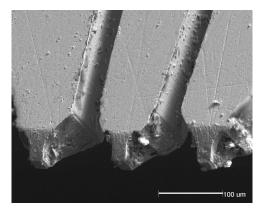
Average rating of maximum power and maximum current (CW) of the $\mid\!\! Z\!\!\mid$ Probe Power GSG.



Long lifetime of IZI Probe (Contact material: AI Overtravel: 75 μm)





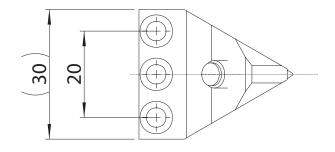


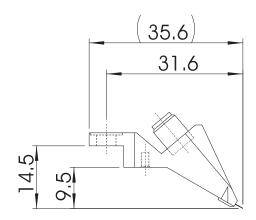
New |Z| Probe (upside-down)

The same probe after 1.5 million touchdowns

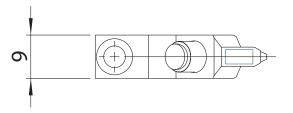
The same probe after three million touchdowns

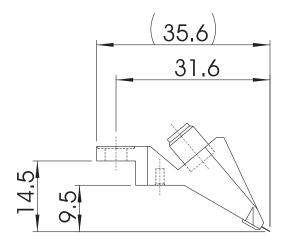
> Physical Dimensions (measurements in mm)





|Z| Probe Power standard case. (All dimensions in mm.)





|Z| Probe Power slim case. (All dimensions in mm.)

© Copyright 2020 FormFactor, Inc. All rights reserved. FormFactor and the FormFactor logo are trademarks of FormFactor, Inc. All other trademarks are the property of their respective owners.

All information is subject to change without notice.

ZProbePower-SS-0620

Corporate Headquarters

7005 Southfront Road Livermore, CA 94551 Phone: 925-290-4000 www.formfactor.com

